

GLASS PASSIVATED BRIDGE RECTIFIERS

REVERSE VOLTAGE - **50 to 1000** Volts
FORWARD CURRENT - **8.0** Amperes

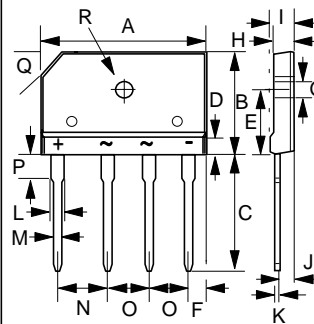
FEATURES

- Rating to 1000V PRV
- Ideal for printed circuit board
- Low forward voltage drop, high current capability.
- Reliable low cost construction utilizing molded plastic technique results in inexpensive product
- The plastic material has UL flammability classification 94V-0
- UL Recognition File # E95060

MECHANICAL DATA

- Polarity : Symbols molded on body
- Weight : 0.23 ounces, 6.6 grams
- Mounting position : Any

GBJ



GBJ		
DIM.	MIN.	MAX.
A	29.70	30.30
B	19.70	20.30
C	17.0	18.0
D	4.70	4.90
E	10.80	11.20
F	2.30	2.70
G	3.10	3.40
H	3.40	3.80
I	4.40	4.80
J	2.50	2.90
K	0.60	0.80
L	2.00	2.40
M	0.90	1.10
N	9.80	10.20
O	7.30	7.70
P	3.80	4.20
Q	(3.0) x 45°	
R	3.10 ϕ	3.40 ϕ

All Dimensions in millimeter

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.
Single phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%

CHARACTERISTICS	SYMBOL	GBJ8005	GBJ801	GBJ802	GBJ804	GBJ806	GBJ808	GBJ810	UNIT
Maximum Recurrent Peak Reverse Voltage	V _{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	V _{RMS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	800	1000	V
Maximum Average Forward (with heatsink Note 2) Rectified Current @T _c =110°C (without heatsink)	I _(AV)					8.0			A
						2.9			
Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load (JEDEC METHOD)	I _{FSM}					170			A
Maximum forward Voltage at 4.0A DC	V _F					1.0			V
Maximum DC Reverse Current @T _J =25°C at Rated DC Blocking Voltage @T _J =125°C	I _R					5.0			uA
						500			
I ² t Rating for fusing (t < 8.3ms)	I ² t					120			A ² S
Typical Junction Capacitance per element (Note 1)	C _J					55			pF
Typical Thermal Resistance (Note 2)	R _{θJC}					1.6			°C/W
Operating Temperature Range	T _J					-55 to +150			°C
Storage Temperature Range	T _{STG}					-55 to +150			°C

NOTES : 1. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.
2. Device mounted on 100mm x 100mm x 1.6mm Cu Plate Heatsink.

REV. 2, 01-Dec-2000, KBDG02

